



PRELIMINARY

SOLID STATE DEVICES, INC

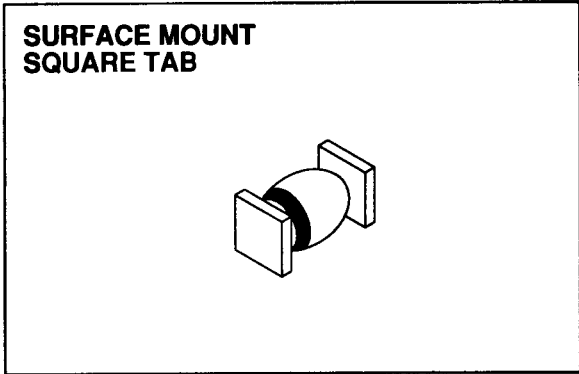
14849 Firestone Boulevard · La Mirada, CA 90638  
Phone: (714) 670-SSDI (7734) · Fax: (714) 522-7424

**SDR1302SMS  
thru  
SDR1308SMS**

**Designer's Data Sheet**

- FEATURES:**
- Ultra Fast Recovery: 70 nsec Max. @ 25°C  
110 nsec Max. @ 100°C
  - Single Chip Construction
  - PIV to 800 Volts
  - Low Reverse Leakage Current
  - Hermetically Sealed Surface Mount package
  - For High Efficiency Applications
  - Replaces Unitrode: UES1304 Series
  - Metallurgically Bonded
  - Available in axial leaded versions
  - TX, TXV and Space Level Screening Available

**3 AMP  
200-800 VOLTS  
70 nsec  
ULTRA FAST  
RECTIFIER**



**MAXIMUM RATINGS**

RATING	SYMBOL	VALUE	UNIT
Peak Repetitive Reverse and DC Blocking Voltage  SDR1302SMS SDR1304SMS SDR1306SMS SDR1308SMS	VRRM  VRWM  VR	200 400 600 800	Volts
Average Rectified Forward Current (Resistive Load, 60Hz, Sine Wave, TA=25°C)	IO	3	Amps
Peak Surge Current (8.3 ms Pulse, Half Sine Wave Superimposed on IO, allow junction to reach equilibrium between pulses, TA=25°C)	IFSM	75	Amps
Operating and storage temperature	Top & Tstg	-65 to +175	°C
Maximum Thermal Resistance Junction to End Tab	RθJE	14	°C/W

NOTE: All specifications are subject to change without notification. SC'D's for these devices should be reviewed by SSDI prior to release.	DATA SHEET #: RU0095 A	RMD
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# SDR1302SMS thru SDR1308SMS

PRELIMINARY



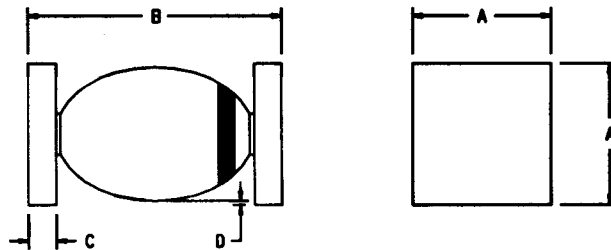
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## ELECTRICAL CHARACTERISTICS

CHARACTERISTICS	SYMBOL	MAXIMUM	UNIT
Instantaneous Forward Voltage Drop ( $I_F = 3 \text{ Adc}$ , $T_A = 25^\circ\text{C}$ , 300 $\mu\text{s}$ Pulse)	$V_F$	1.35	Vdc
Instantaneous Forward Voltage Drop ( $I_F = 3 \text{ Adc}$ , $T_A = -55^\circ\text{C}$ , 300 $\mu\text{s}$ Pulse)	$V_F$	1.5	Vdc
Reverse Leakage Current (Rated $V_R$ , $T_A = 25^\circ\text{C}$ , 300 $\mu\text{s}$ pulse minimum)	$I_R$	20	$\mu\text{A}$
Reverse Leakage Current (Rated $V_R$ , $T_A = 100^\circ\text{C}$ , 300 $\mu\text{s}$ pulse minimum)	$I_R$	1	mA
Junction Capacitance ( $V_R = 10 \text{ Vdc}$ , $T_A = 25^\circ\text{C}$ , $f = 1\text{MHz}$ )	$C_J$	50	pf
Reverse Recovery Time ( $I_F = 500\text{ma}$ , $I_R = 1\text{A}$ , $I_{RR} = 250\text{mA}$ , $T_A = 25^\circ\text{C}$ )	$t_{rr}$	70	nsec

## CASE OUTLINE:



## DIMENSIONS

DIM	MIN.	MAX.
A	.172"	.180"
B	.180"	.280"
C	.022"	.028"
D	.002"	---

Dimensions prior to solder dipping.

## TYPICAL OPERATING CURVES

$T_A = 25^\circ\text{C}$  Unless otherwise specified

